December

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146839 - 3 Product Details



146839 -3



Removable Memory Products

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- ? Number of Positions = 50
- ? Format = CompactFlash™
- ? CompactFlash™ Product Type = Header Only
- ? Header Type = Type I
- Lead Type = Surface Mount Staggered leads

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Product Feature
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Documentation & Additional Information

Product Drawings:

PIN HEADER ASSEMBLY, VERTICAL, 50 POSN, SURFACE MOUNT, (PDF, English)

Catalog Pages/Data Sheets:

? None Available

Product Specifications:

? None Available

Application Specifications:

None Available

Instruction Sheets:

? None Available

CAD Files: (CAD Format & Compression Information

- 2 2D Drawing (DXF, Version D)
- ? 3D Model (IGES, Version D)
- ? 3D Model (STEP, Version D)

Related Products:

? Tooling

List all Documents

Product Features (Please use the Product Drawing for all design activity)

- Product Type Features:

 Number of Positions = 50
 - ? Mount Angle = Vertical
 - ? Holddowns = Without
 - ? Shielded = No
 - Color = Black

Termination Related Features:

? Solder Tail Contact Plating = Tin

Body Related Features:

- ² CompactFlash™ Product Type = Header Only
- ? Header Type = Type I
- Lead Type = Surface Mount Staggered leads
- ? Number of Rows = Dual
- ? Centerline (mm [in]) = 1.27 [0.050]

Contact Related Features:

- ? Contact Mating Area Plating Material = Gold (30)
- ? Vacuum Tape = With
- Region = Americas
- ? Contact Material = Brass
- ? Contact Underplating = Nickel (50)

Housing Related Features:

- Housing Material = Liquid Crystal Polymer (LCP)
- [?] Housing Flammability Rating = UL 94V -0

Industry Standards:

- ? RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- ? RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

? Format = CompactFlash™

Packaging Related Features:

Packaging Method = Tube

Other:

? Brand = AMP

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